RELIABILITY REPORT
FOR

DS2423, Rev A3

Dallas Semiconductor

4401 South Beltwood Parkway
Dallas, TX 75244-3292

Prepared by:

Ken Wendel
Reliability Engineering Manager
Dallas Semiconductor
4401 South Beltwood Pkwy.
Dallas, TX 75244-3292
Email : ken.wendel@dalsemi.com
ph: 972-371-3726
fax: 972-371-6016
mbl: 214-435-6610

Conclusion:

The following qualification successfully meets the quality and reliability standards required of all Dallas Semiconductor products and processes:

DS2423, Rev A3

In addition, Dallas Semiconductor's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at http://www.maxim-ic.com/TechSupport /dsreliability.html.

Device Description:

A description of this device can be found in the product data sheet. You can find the product data sheet at http://dbserv.maxim-ic.com/l_datasheet3.cfm.

Reliability Derating:

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

$$AfT = \exp((Ea/k)*(1/Tu - 1/Ts)) = tu/ts$$
AfT = Acceleration factor due to Temperature
tu = Time at use temperature (e.g. 55°C)
ts = Time at stress temperature (e.g. 125°C)
k = Boltzmann's Constant (8.617 x 10-5 eV/°K)
Tu = Temperature at Use (°K)
Ts = Temperature at Stress (°K)
Ea = Activation Energy (e.g. 0.7 ev)

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

$$AfV = \exp(B*(Vs - Vu))$$
AfV = Acceleration factor due to Voltage
Vs = Stress Voltage (e.g. 7.0 volts)
Vu = Maximum Operating Voltage (e.g. 5.5 volts)
B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)

The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

$$Fr = X/(ts * AfV * AfT * N * 2)$$
X = Chi-Sq statistical upper limit
N = Life test sample size

Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

MTTF = 1/Fr

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

FAILURE RATE: **MTTF (YRS): 13968** **FITS: 8.2**

The parameters used to calculate this failure rate are as follows:

Cf: 60% **Ea: 0.7** **B: 0** **Tu: 25** **°C** **Vu: 5.5** **Volts**

The reliability data follows. A the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available and may contain some generic data.

Device Information:

Process:	1P, 1M, 0.8um, Pdepletion, , BPSG ILO ,
Passivation:	Laser/TEOS Ox - Pass/Nit - Gen.LaserPrb
Interconnect:	Aluminum / 1% Silicon / 0.5% Copper
Gate Oxide Thickness:	175 Å

OPERATING LIFE

DESCRIPTION	DATE CODE	CONDITION	READPOINT		QTY	FAILS	FA#
INFANT LIFE	9728	125C, 7.0 VOLTS	48	HRS	315	0	
HIGH VOLTAGE LIFE	9728	125C, 7.0 VOLTS	1001	HRS	116	0	
INFANT LIFE	9813	125C, 7.0 VOLTS	48	HRS	315	1	980140
HIGH VOLTAGE LIFE	9813	125C, 7.0 VOLTS	1000	HRS	116	0	
				Total:		1	

TEMPERATURE CYCLE

DESCRIPTION	DATE CODE	CONDITION	READPOINT		QTY	FAILS	FA#
TEMP CYCLE	9728	-55C TO 125C	1000	CYS	77	0	
CONSTRUCTION ANALYSIS		TO BE DONE BY F/A	1	WKS	5	0	
TEMP CYCLE	9813	-55C TO 125C	1000	CYS	77	0	
				Total:		0	

TEMPERATURE HUMIDITY BIAS

DESCRIPTION	DATE CODE	CONDITION	READPOINT		QTY	FAILS	FA#
BIASED MOISTURE	9728	85/85, 5.5 VOLTS	959	HRS	77	0	
CONSTRUCTION ANALYSIS		TO BE DONE BY F/A	960	WKS	5		
BIASED MOISTURE	9813	85/85, 5.5 VOLTS	959	HRS	77	0	
				Total:		0	

UNBIASED MOISTURE RESISTANCE

DESCRIPTION	DATE CODE	CONDITION	READPOINT		QTY	FAILS	FA#
AUTOCLAVE	9728	121C, 2 ATM STEAM, UNBIASED	168	HRS	45	0	

CONSTRUCTION ANALYSIS	9728	TO BE DONE BY F/A	1	WKS	45	
AUTOCLAVE	9813	121C, 2 ATM STEAM, UNBIASED	168	HRS	42	0
				Total:		**0**

FAILURE RATE: **MTTF (YRS): 13968**   **FITS: 8.2**